

Resin Bond Diamond Grinding Wheel

This high-precision resin bond diamond grinding wheel is designed for accurate and efficient material processing. It features a durable construction with diamond abrasive for extended lifespan and consistent performance.



Product Overview

Professional Ceramic Tile Squaring Solution

This resin bond diamond squaring wheel is engineered to ensure precise uprightness and accurate sizing for large-format ceramic, porcelain, and polished tiles. The design features a specialized bond and diamond abrasive matrix that delivers exceptional sharpness while minimizing noise levels during operation. By providing clean edges without chipping or breaking, this tool optimizes material quality and reduces waste in industrial tiling applications.

Technical Specifications

Bond Type	Resin Bond
Target Materials	Glazed Ceramic Tiles, Porcelain Tiles, Polished Porcelain Tiles

Quality & Standards

Certifications

ISO 9001 • ISO 14001 • OHSAS 18001

Performance Features

Operational Advantages

- High sharpness for efficient material removal
- Extended operational lifetime
- Reduced noise emission during grinding
- Precise edge squaring without chipping
- Stable quality control

Classification

Classification by Mode

Category	Description
Peripheral Wheel	Based on grinding/cutting mode
Disk Wheel	Based on grinding/cutting mode